

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	722	(planariz\$3) same (solder\$3 or bump\$3)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:34
2	BRS	L2	18007	(reflow\$3 or reform\$3) with (solder\$3 or bump\$3)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:34
3	IS&R	L3	1014	(257/738).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:34
4	BRS	L4	491	((257/738).CCLS.) and (reflow\$3 or reform\$3)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:34
5	BRS	L5	197	((257/738).CCLS.) and (reflow\$3 or reform\$3) and encapsulat\$3	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:34

	Type	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L6	18007	(reform\$3 or reflow\$3) with (solder\$3 or bump\$3)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:34
7	BRS	L7	1226	platen with (solder\$3 or bump\$3 or ball\$3)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:35
8	BRS	L8	85	((planariz\$3) same (solder\$3 or bump\$3)) same (reform\$3 or reflow\$3)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:35
9	BRS	L9	22	planariz\$3 same (reflow\$3) same solder\$3 same bump\$3	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:35
10	BRS	L10	72	((reflow\$3 or reform\$3) with (solder\$3 or bump\$3)) same planariz\$3	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:35

	Type	L #	Hits	Search Text	DBs	Time Stamp
11	BRS	L11	10	((((257/738).CCLS.) and (reflow\$3 or reform\$3)) and encapsulat\$3) and planariz\$3	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:35
12	BRS	L12	22	planariz\$3 with reflow\$3 with (solder\$3 or bump\$3)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:35
13	BRS	L13	72	((reform\$3 or reflow\$3) with (solder\$3 or bump\$3)) same planariz\$3	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:35
14	BRS	L14	41	(platen with (solder\$3 or bump\$3 or ball\$3)) same planariz\$3	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:35
15	BRS	L15	66	(planariz\$3) same (solder\$3) same bump\$3	USPAT	2003/02/28 17:35
16	BRS	L17	7	(reform\$3) with preplanariz\$3	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:35

	Type	L #	Hits	Search Text	DBs	Time Stamp
17	IS&R	L18	520	(438/631).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:45
18	IS&R	L19	2	("5677576").PN.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/02/28 17:45